# Low-Voltage CMOS 3-to-8 Decoder/Demultiplexer

With 5 V–Tolerant Inputs

# MC74LCX138

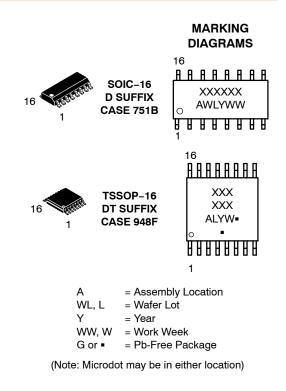
The MC74LCX138 is a high performance, 3-to-8 decoder/demultiplexer operating from a 1.65 to 5.5 V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V<sub>I</sub> specification of 5.5 V allows MC74LCX138 inputs to be safely driven from 5 V devices. The MC74LCX138 is suitable for memory address decoding and other TTL level bus-oriented applications.

The MC74LCX138 high-speed 3-to-8 decoder/demultiplexer accepts three binary weighted inputs (A0, A1, A2) and, when enabled, provides eight mutually exclusive active-LOW outputs ( $\overline{O0}-\overline{O7}$ ). The LCX138 features three Enable inputs, two active-LOW ( $\overline{E1}$ ,  $\overline{E2}$ ) and one active-HIGH (E3). All outputs will be HIGH unless  $\overline{E1}$  and  $\overline{E2}$  are LOW, and E3 is HIGH. This multiple enabled function allows easy parallel expansion of the device to a 1-of-32 (5 lines to 32 lines) decoder with just four LCX138 devices and one inverter (see Figure 1). The LCX138 can be used as an 8-output demultiplexer by using one of the active-LOW Enable inputs as the data input and the other Enable inputs as strobes. The Enable inputs which are not used must be permanently tied to their appropriate active-HIGH or active-LOW state.

Current drive capability is 24 mA at the outputs at 3 V.

#### Features

- Designed for 1.65 V to 5.5 V V<sub>CC</sub> Operation
- 5 V Tolerant Inputs Interface Capability With 5 V TTL Logic
- LVTTL Compatible
- LVCMOS Compatible
- 24 mA Balanced Output Sink and Source Capability at 3 V
- Near Zero Static Supply Current (10 µA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 100 mA
- ESD Performance: Human Body Model >2000 V
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet. NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 7.

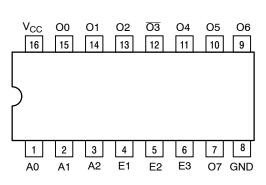


Figure 1. Pinout: 16-Lead (Top View)

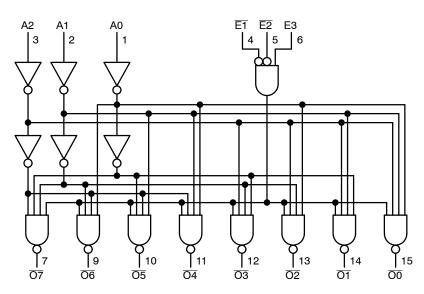


Figure 2. Logic Diagram

#### **PIN NAMES**

Pins	Function
<u>A0-A2</u>	Address Inputs
E1-E2	Enable Inputs
<u>E3</u>	Enable Input
00–07	Outputs

#### **TRUTH TABLE**

		Inp	uts			Outputs							
E1	E2	E3	A0	A1	A2	00	01	02	03	04	05	06	07
Н	Х	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
Х	Н	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
Х	Х	L	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
L	L	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
L	L	Н	Н	L	L	Н	L	Н	Н	Н	Н	Н	Н
L	L	Н	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н
L	L	н	Н	Н	L	Н	Н	Н	L	Н	Н	Н	Н
L	L	Н	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н
L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н
L	L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

H = High Voltage Level

L = Low Voltage Level

X = High or Low Voltage Level and Transitions are Acceptable

For  $I_{\mbox{\scriptsize CC}}$  reasons, DO NOT FLOAT Inputs

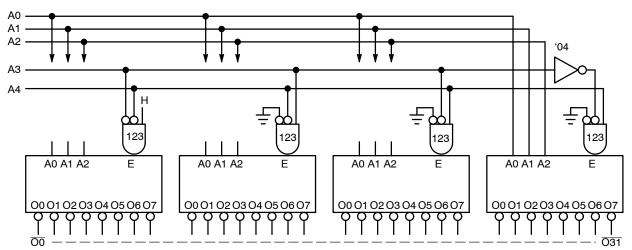


Figure 3. Expansion to 1-of-32 Decoding

#### **MAXIMUM RATINGS**

Symbol	Parame	ter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +6.5	V
VI	DC Input Voltage (Note 1)		–0.5 to +6.5	V
V <sub>O</sub>	DC Output Voltage (Note 1)	Active-Mode (High or Low State) Tri-State Mode Power-Down Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +6.5 -0.5 to +6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>I</sub> < GND	-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	V <sub>O</sub> < GND	-50	mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Groun	d Pin	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10	secs	260	°C
TJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 1)	SOIC-16 WQFN-16 TSSOP-16	126 114 159	°C/W
P <sub>D</sub>	Power Dissipation in Still Air at 25°C	SOIC-16 WQFN-16 TSSOP-16	995 1094 787	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating Oxygen Index: 28 to 34		UL 94 V-0 @ 0.125 in	-
V <sub>ESD</sub>	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 N/A	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I<sub>O</sub> absolute maximum rating must be observed.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Pa	arameter	Min	Тур	Max	Unit
V <sub>CC</sub>	Supply Voltage	Operating Data Retention Only	1.65 1.5	3.3 3.3	5.5 5.5	V
VI	Digital Input Voltage		0	-	5.5	V
Vo	Output Voltage	Active Mode (High or Low State) Tri-State Mode Power Down Mode (V <sub>CC</sub> = 0 V)	0 0 0	- - -	V <sub>CC</sub> 5.5 5.5	V
T <sub>A</sub>	Operating Free-Air Temperature		-40	-	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Rate	$\label{eq:VCC} \begin{array}{c} V_{CC} = 1.65 \; V \; to \; 1.95 \; V \\ V_{CC} = 2.3 \; V \; to \; 2.7 \; V \\ V_{I} \; from \; 0.8 \; V \; to \; 2.0 \; V, \; V_{CC} = 3.0 \; V \\ V_{CC} = 4.5 \; V \; to \; 5.5 \; V \end{array}$	0 0 0 0	- - - -	20 20 10 5	nS/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

				T <sub>A</sub> = -40 °C	C to +85 °C	T <sub>A</sub> = -40 °C	to +125 °C	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Min	Max	Uni
V <sub>IH</sub>	HIGH Level Input Voltage		1.65 – 1.95	0.65 x V <sub>CC</sub>	-	0.65 x V <sub>CC</sub>	-	V
			2.3 – 2.7	1.7	-	1.7	_	
			3.0-3.6	2.0	-	2.0	-	
			4.5 – 5.5	0.70 x V <sub>CC</sub>	-	0.70 x V <sub>CC</sub>	_	
V <sub>IL</sub>	LOW Level Input Voltage		1.65 – 1.95	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	V
			2.3 – 2.7	-	0.7	-	0.7	
			3.0 - 3.6	-	0.8	-	0.8	
			4.5 – 5.5	-	0.30 x V <sub>CC</sub>	-	0.30 x V <sub>CC</sub>	
V <sub>OH</sub>	High-Level Output Voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = -100 μA	1.65 to 5.5	V <sub>CC</sub> – 0.1	_	V <sub>CC</sub> – 0.1	_	V
		$I_{OH} = -4 \text{ mA}$	1.65	1.29	-	1.29	_	
		I <sub>OH</sub> = -8 mA	2.3	1.8	-	1.8	-	
		I <sub>OH</sub> = -12 mA	2.7	2.2	-	2.2	-	
		I <sub>OH</sub> = -16 mA	3.0	2.4	-	2.4	-	
		I <sub>OH</sub> = -24 mA	3.0	2.2	-	2.2	-	
		I <sub>OH</sub> = -32 mA	4.5	3.7		3.7	-	
V <sub>OL</sub>	Low-Level Output Voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						V
		I <sub>OL</sub> = 100 μA	1.65 to 5.5	-	0.1	-	0.1	
		I <sub>OL</sub> = 4 mA	1.65	-	0.24	-	0.24	
		I <sub>OL</sub> = 8 mA	2.3	-	0.3	-	0.3	
		I <sub>OL</sub> = 12 mA	2.7	-	0.4	-	0.4	
		I <sub>OL</sub> = 16 mA	3.0	-	0.4	-	0.4	
		I <sub>OL</sub> = 24 mA	3.0	-	0.55	-	0.55	
		I <sub>OL</sub> = 32 mA	4.5	-	0.6	-	0.6	
II.	Input Leakage Current	$V_I = 0$ to 5.5 V	3.6	-	±5.0	-	±5.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	V <sub>I</sub> = 5.5 V or V <sub>O</sub> = 5.5 V	0	-	10	-	10	μA

#### DC ELECTRICAL CHARACTERISTICS

#### DC ELECTRICAL CHARACTERISTICS (continued)

				T <sub>A</sub> = -40 °C	C to +85 °C	T <sub>A</sub> = -40 °C	to +125 °C	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Мах	Min	Мах	Unit
I <sub>CC</sub>	Quiescent Supply Current	$V_{I}$ = 5.5 V or GND	3.6	-	10	-	10	μΑ
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6 V$	2.3 to 3.6	-	500	-	500	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### AC ELECTRICAL CHARACTERISTICS

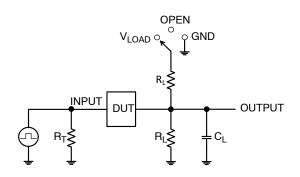
				T <sub>A</sub> = -40 °	C to +85 °C	T <sub>A</sub> = -40 °C	to +125 °C		
Symbol	Parameter	Test Condition	V <sub>CC</sub> (V)	Min	Max	Min	Max	Unit	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	See Figures 4 and 5	1.65 to 1.95	-	11.5	-	11.5	ns	
	An to On		2.3 to 2.7	-	7.2	-	7.2		
			2.7	-	7.0	-	7.0		
			3.0 to 3.6	-	6.0	-	6.0		
			4.5 to 5.5	-	5.0	-	5.0		
t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLH</sub> , t <sub>PHL</sub> Propagation Delay, E1, E2 to On See Figures 4 and 5	See Figures 4 and 5	1.65 to 1.95	-	12.0	-	12.0	ns	
			2.3 to 2.7	-	8.4	-	8.4		
				2.7	-	7.5	-	7.5	
			3.0 to 3.6	-	6.5	-	6.5		
			4.5 to 5.5	-	5.5	-	5.5		
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	See Figures 4 and 5	1.65 to 1.95	-	11.5	-	11.5	ns	
	E3 to On		2.3 to 2.7	-	7.2	-	7.2		
			2.7	-	7.0	-	7.0		
			3.0 to 3.6	-	6.0	-	6.0		
			4.5 to 5.5	-	5.0	-	5.0		
t <sub>OSHL</sub> ,	Output to Output Skew		1.65 to 1.95	-	-	-	-	ns	
t <sub>OSLH</sub>	(Note 5)		2.3 to 2.7	-	-	-	-		
			2.7	-	-	-	-		
			3.0 to 3.6	-	1.0	-	1.0		
			4.5 to 5.5	-	-	-	-		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>). Parameter guaranteed by design.

#### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Condition	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	10 MHz, $V_{CC}$ = 3.3 V, $V_{I}$ = 0 V or $V_{CC}$	25	pF



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Test	Switch Position
t <sub>PLH</sub> / t <sub>PHL</sub>	Open
t <sub>PLZ</sub> / t <sub>PZL</sub>	V <sub>LOAD</sub>
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND

 $C_L$  includes probe and jig capacitance  $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega)$  f = 1 MHz

10%

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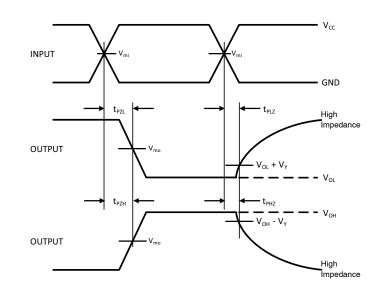
 $t_{\text{PLH}}$ 

t<sub>r</sub> = 2.5 ns

INPUT

OUTPUT

OUTPUT



Figur	e 4	Test	Circuit
i iyui	ς τ.	ICOL	Uncun

t<sub>f</sub> = 2.5 ns

10%

۷.

V<sub>ma</sub>

t<sub>PLH</sub>

 $t_{\text{PHL}}$ Þ

Vcc

GND

V<sub>OH</sub>

V<sub>OH</sub>

 $V_{\text{OL}}$ 

-Vol

V <sub>CC</sub> , V	$R_{L}, \Omega$	C <sub>L</sub> , pF	V <sub>LOAD</sub>	v <sub>m</sub> , v	V <sub>Y</sub> , V
1.65 to 1.95	500	30	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.15
2.3 to 2.7	500	30	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.15
2.7	500	50	6 V	1.5	0.3
3.0 to 3.6	500	50	6 V	1.5	0.3
4.5 to 5.5	500	50	$2 \times V_{CC}$	V <sub>CC</sub> /2	0.3

Figure 5. Switching Waveforms

#### **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
MC74LCX138DR2G	LCX138	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74LCX138DTG	LCX 138	TSSOP-16 (Pb-Free)	96 Units / Rail
MC74LCX138DTR2G	LCX 138	TSSOP-16 (Pb-Free)	2500 Tape & Reel

#### **DISCONTINUED** (Note 6)

NLV74LCX138DR2G*         LCX138         SOIC-16         2500 Tape & Reg           (Pb-Free)         (Pb-Free)         (Pb-Free)         (Pb-Free)	leel
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†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>. \*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable.

6. DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on www.onsemi.com.



MILLIMETERS

NOM

1.55

0.18

1.37

0.42

0.22

9.90 BSC

MIN

1.35

0.10

1.25

0.35

0.19

DIM

А

Α1

A2

b

С

D

#### SOIC-16 9.90x3.90x1.37 1.27P CASE 751B ISSUE M

#### DATE 18 OCT 2024

MAX

1.75

0.25

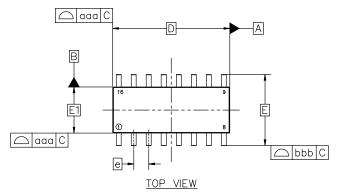
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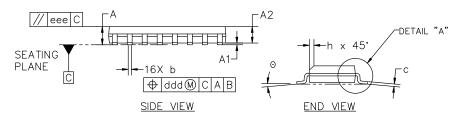
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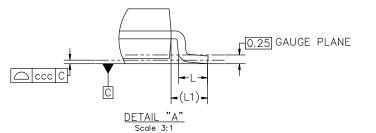
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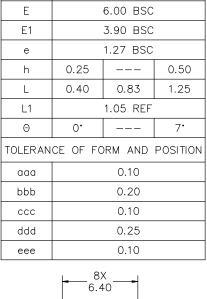
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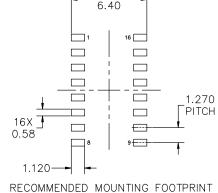
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
- 3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
- DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE & DIMENSION AT MAXIMUM MATERIAL CONDITION.











ECOMMENDED MOUNTING FOOTPRINT \*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE onsemi SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D

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DESCRIPTION:	SOIC-16 9.90X3.90X1.37 1	PAGE 1 OF 2			

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#### SOIC-16 9.90x3.90x1.37 1.27P CASE 751B ISSUE M

#### DATE 18 OCT 2024

#### GENERIC MARKING DIAGRAM\*

16	A	H	A.	- A	R	A	A	Æ
		XX)						
		XX	XX	XX	XX	XX)	XX	x
	0				YW			
1	H	H	Н	Н	Н	Н	H	Т

XXXXX = Specific Device Code

A = Assembly Location

- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

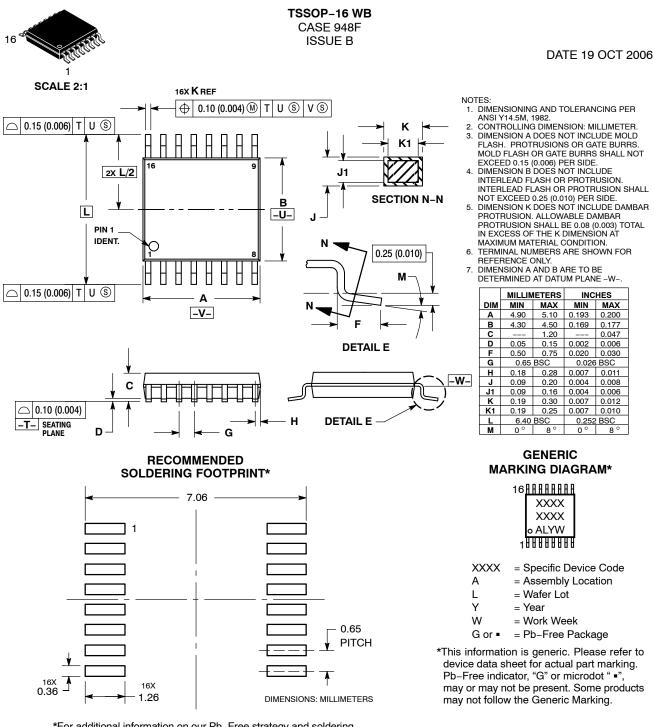
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:		STYLE 2:		STYLE 3:		STYLE 4:	
PIN 1.		PIN 1.		PIN 1.	COLLECTOR, DYE #1	PIN 1.	
2.		2.	ANODE	2.	BASE, #1	2.	
3.	EMITTER	3.	NO CONNECTION	3.	EMITTER, #1	3.	••••
4.	NO CONNECTION	4.	CATHODE	4.	COLLECTOR, #1	4.	
5.		5.	CATHODE	5.	COLLECTOR, #2	5.	COLLECTOR, #3
6.		6.	NO CONNECTION	6.	BASE, #2	6.	COLLECTOR, #3
7.	COLLECTOR	7.	ANODE	7.	EMITTER, #2	7.	COLLECTOR, #4
8.	COLLECTOR	8.	CATHODE	8.	COLLECTOR, #2	8.	COLLECTOR, #4
9.	BASE	9.	CATHODE	9.	COLLECTOR, #3	9.	BASE, #4
10.	EMITTER	10.	ANODE	10.	BASE, #3	10.	EMITTER, #4
11.	NO CONNECTION	11.	NO CONNECTION	11.	EMITTER, #3	11.	BASE, #3
12.	EMITTER	12.	CATHODE	12.	COLLECTOR, #3	12.	EMITTER, #3
13.	BASE	13.	CATHODE	13.	COLLECTOR, #4	13.	BASE, #2
14.	COLLECTOR	14.	NO CONNECTION	14.	BASE, #4	14.	EMITTER, #2
15.	EMITTER	15.	ANODE	15.	EMITTER, #4	15.	BASE, #1
16.	COLLECTOR	16.	CATHODE	16.	COLLECTOR, #4	16.	EMITTER, #1
STVLE 5		STVLE 6		STVLE 7			
STYLE 5: PIN 1	DRAIN DYE #1	STYLE 6: PIN 1	CATHODE	STYLE 7: PIN 1	SOURCE N-CH		
PIN 1.	DRAIN, DYE #1 DRAIN #1	PIN 1.	CATHODE	PIN 1.	SOURCE N-CH	h	
PIN 1. 2.	DRAIN, #1	PIN 1. 2.	CATHODE	PIN 1. 2.	COMMON DRAIN (OUTPUT		
PIN 1. 2. 3.	DRAIN, #1 DRAIN, #2	PIN 1. 2. 3.	CATHODE CATHODE	PIN 1. 2. 3.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT		
PIN 1. 2. 3. 4.	DRAIN, #1 DRAIN, #2 DRAIN, #2	PIN 1. 2. 3. 4.	CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH	)	
PIN 1. 2. 3. 4. 5.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3	PIN 1. 2. 3. 4. 5.	CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT	)	
PIN 1. 2. 3. 4. 5. 6.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3	PIN 1. 2. 3. 4. 5. 6.	CATHODE CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5. 6.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT	) )	
PIN 1. 2. 3. 4. 5. 6. 7.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4	PIN 1. 2. 3. 4. 5. 6. 7.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5. 6. 7.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT	) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #4 DRAIN, #4	PIN 1. 2. 3. 4. 5. 6. 7. 8.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE	PIN 1. 2. 3. 4. 5. 6. 7. 8.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH	) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH	) ) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT	) ) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 GATE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT	) ) ) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10. 11.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 GATE, #3 SOURCE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT	) ) ) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 SOURCE, #3 SOURCE, #3 SOURCE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE N-CH	) ) ) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 GATE, #3 SOURCE, #2 SOURCE, #2	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 12. 13. 14.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE N-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT	) ) ) ) )	
PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	DRAIN, #1 DRAIN, #2 DRAIN, #2 DRAIN, #3 DRAIN, #3 DRAIN, #4 DRAIN, #4 DRAIN, #4 GATE, #4 SOURCE, #4 SOURCE, #3 SOURCE, #3 SOURCE, #3	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 9. 10. 11. 12. 13. 13. 14. 15.	CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE CATHODE ANODE ANODE ANODE ANODE ANODE ANODE	PIN 1. 2. 3. 4. 5. 6. 7. 8. 9. 10. 11. 11. 12. 13.	COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT SOURCE P-CH SOURCE P-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT GATE N-CH COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT COMMON DRAIN (OUTPUT	) ) ) ) )	

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